



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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NYC0102BLT1G

Sensitive Gate Silicon Controlled Rectifiers Reverse Blocking Thyristors

Designed and tested for highly-sensitive triggering in low-power switching applications.

Features

- High dv/dt
- Gating Current < 200 μ A
- Miniature SOT-23 Package for High Density PCB
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) ($R_{GK} = 1\text{K}$, $T_J = -40$ to $+110^\circ\text{C}$, Sine Wave, 50 to 60 Hz)	V_{DRM} , V_{RRM}	200	V
On-State Current RMS (180° Conduction Angle, $T_C = 80^\circ\text{C}$)	$I_{T(RMS)}$	0.25	A
Peak Non-repetitive Surge Current, $T_A = 25^\circ\text{C}$, (1/2 Cycle, Sine Wave, 60 Hz)	I_{TSM}	7.0	A
Circuit Fusing Considerations ($t = 8.3$ ms)	I^2t	0.2	A^2s
Forward Peak Gate Power (Pulse Width ≤ 1.0 μsec , $T_A = 25^\circ\text{C}$)	P_{GM}	0.1	W
Forward Average Gate Power ($t = 8.3$ msec, $T_A = 25^\circ\text{C}$)	$P_{G(AV)}$	0.02	W
Forward Peak Gate Current (Pulse Width ≤ 20 μs , $T_A = 25^\circ\text{C}$)	I_{FGM}	0.5	A
Reverse Peak Gate Voltage (Pulse Width ≤ 1.0 μs , $T_A = 25^\circ\text{C}$)	V_{RGM}	8.0	V
Operating Junction Temperature Range @ Rated V_{RRM} and V_{DRM}	T_J	-40 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{stg}	-40 to +150	$^\circ\text{C}$

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board $T_A = 25^\circ\text{C}$	P_D	225	mW
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	380	$^\circ\text{C}/\text{W}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

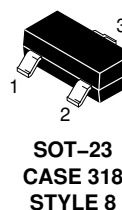
1. V_{DRM} and V_{RRM} for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



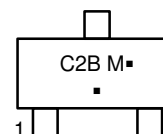
Expertise Applied | Answers Delivered

Littelfuse.com

0.25 AMP, 200 VOLT SCRs



MARKING DIAGRAM



C2B = Specific Device Code
M = Date Code*
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

PIN ASSIGNMENT

Pin	Assignment
1	Cathode
2	Gate
3	Anode

ORDERING INFORMATION

Device	Package	Shipping
NYC0102BLT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel
SZNYC0102BLT1G	SOT-23 (Pb-Free)	3000 / Tape & Reel

NYC0102BLT1G

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
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OFF CHARACTERISTICS

Peak Repetitive Forward Blocking Current ($V_{\text{DRM}} = 200\text{ V}$, $R_{\text{GK}} = 1\text{ k}\Omega$)	I_{DRM}	$T_C = 25^\circ\text{C}$	-	-	1.0	μA
		$T_C = 125^\circ\text{C}$	-	-	100	μA
Peak Repetitive Reverse Blocking Current ($V_{\text{DRM}} = 200\text{ V}$, $R_{\text{GK}} = 1\text{ k}\Omega$)	I_{RRM}	$T_C = 25^\circ\text{C}$	-	-	1.0	μA
		$T_C = 125^\circ\text{C}$	-	-	100	μA

ON CHARACTERISTICS

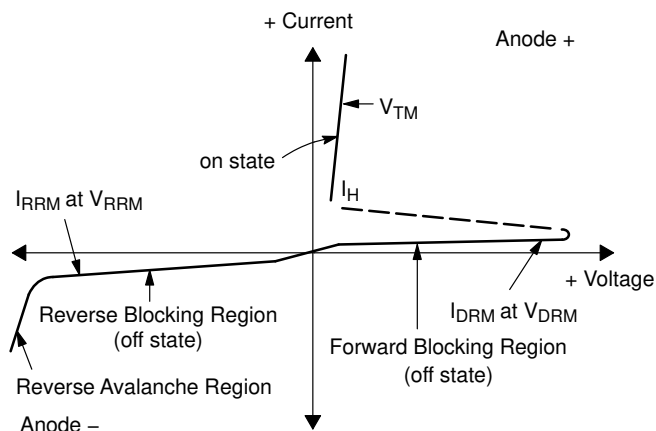
Peak Forward On-State Voltage ($I_{\text{TM}} = 0.4\text{ A}$, $t_p < 1\text{ ms}$, $T_C = 25^\circ\text{C}$)	V_{TM}	-	-	1.7	V
Gate Trigger Current ($V_{\text{D}} = 12\text{ V}$, $R_{\text{L}} = 100\ \Omega$, $T_C = 25^\circ\text{C}$)	I_{GT}	-	-	200	μA
Gate Trigger Voltage ($V_{\text{D}} = 12\text{ V}$, $R_{\text{L}} = 100\ \Omega$, $T_C = 25^\circ\text{C}$)	V_{GT}	-	-	0.8	V
Holding Current ($I_{\text{T}} = 50\text{ mA}$, $R_{\text{GK}} = 1\text{ k}\Omega$, $T_C = 25^\circ\text{C}$)	I_{H}	-	-	6.0	mA
Gate Non-Trigger Voltage ($V_{\text{D}} = V_{\text{DRM}}$, $R_{\text{L}} = 3.3\text{ k}\Omega$, $T_C = 125^\circ\text{C}$)	V_{GD}	0.1	-	-	V
Latching Current ($I_{\text{G}} = 1.0\text{ mA}$, $R_{\text{GK}} = 1\text{ k}\Omega$, $T_C = 25^\circ\text{C}$)	I_{L}	-	-	7.0	mA
Gate Reverse Voltage ($I_{\text{RG}} = 10\ \mu\text{A}$)	V_{RG}	8.0	-	-	V

DYNAMIC CHARACTERISTICS

Critical Rate of Rise of Off-State Voltage ($R_{\text{GK}} = 1\text{ k}\Omega$, $T_C = 125^\circ\text{C}$)	dv/dt	200	-	-	$\text{V}/\mu\text{s}$
Critical Rate of Rise of On-State Current ($I_{\text{G}} = 2 \times I_{\text{GT}}$, 60 Hz , $t_r < 100\text{ ns}$, $T_J = 125^\circ\text{C}$)	di/dt	-	-	50	$\text{A}/\mu\text{s}$

Voltage Current Characteristic of SCR

Symbol	Parameter
V_{DRM}	Peak Repetitive Off State Forward Voltage
I_{DRM}	Peak Forward Blocking Current
V_{RRM}	Peak Repetitive Off State Reverse Voltage
I_{RRM}	Peak Reverse Blocking Current
V_{TM}	Peak on State Voltage
I_{H}	Holding Current



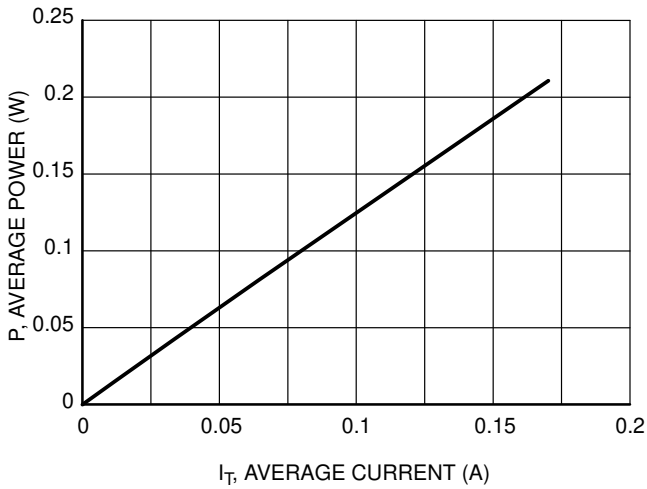


Figure 1. Maximum Average Power vs. Average Current

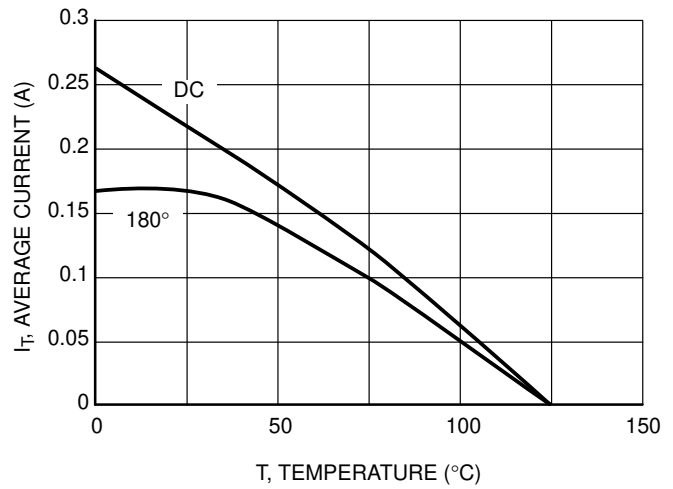


Figure 2. Current Derating

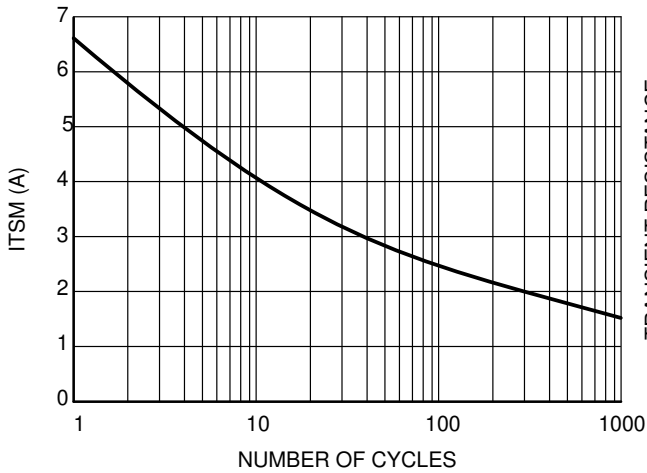


Figure 3. Surge Current ITSM vs. Number of Cycles

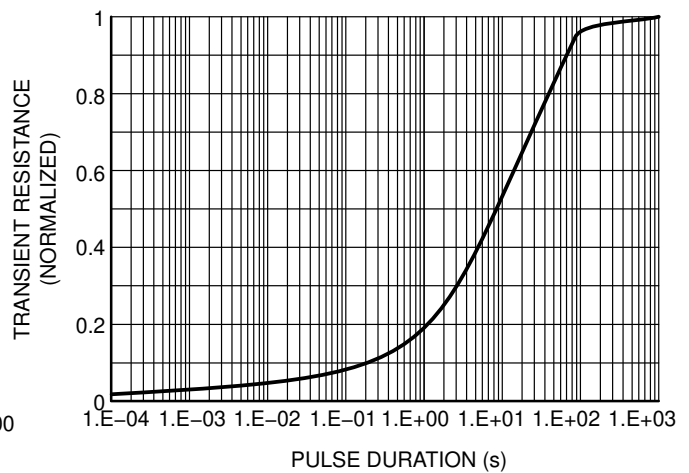


Figure 4. Thermal Response

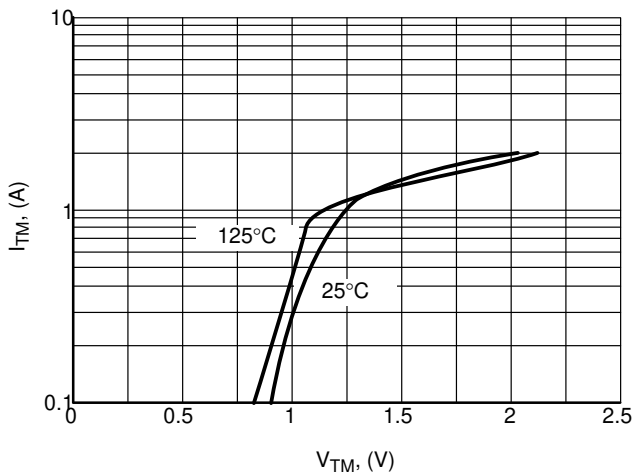


Figure 5. ON-State Characteristics

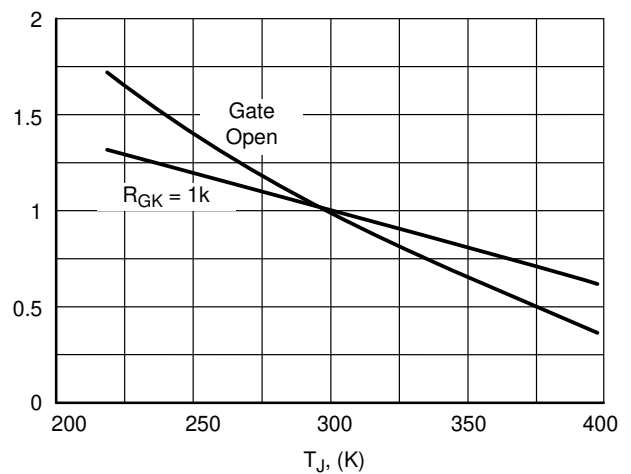
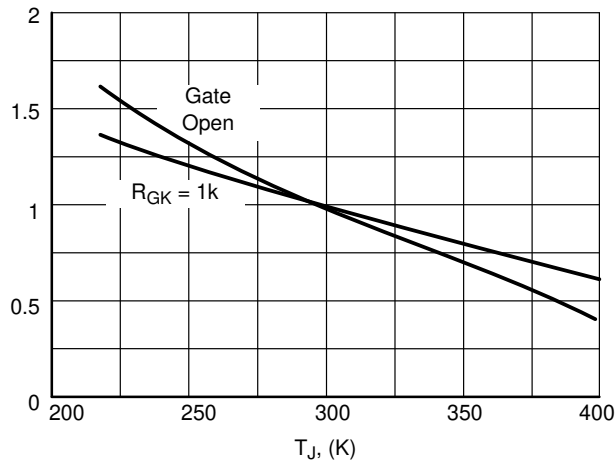


Figure 6. Gate Trigger Current vs. T_J (Normalized to 25°C)

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**Figure 7. Gate Trigger Current vs. T_J
(Normalized to 25°C)**

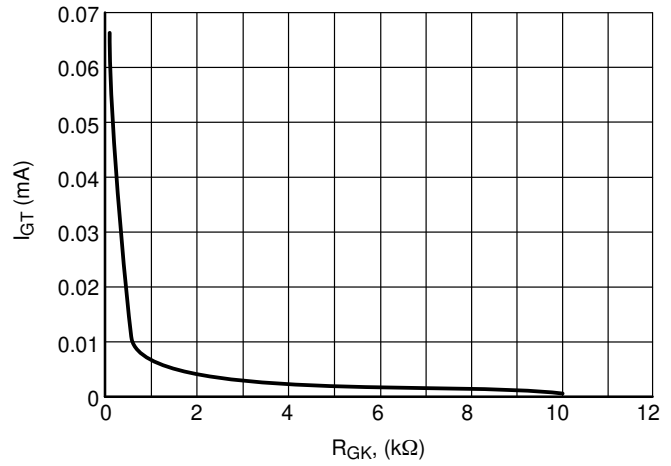


Figure 8. Gate Trigger Current vs. R_{GK}

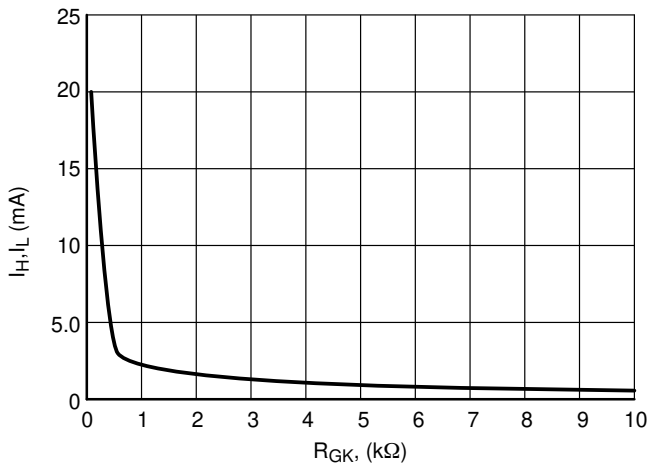


Figure 9. Holding and Latching Current vs. R_{GK}

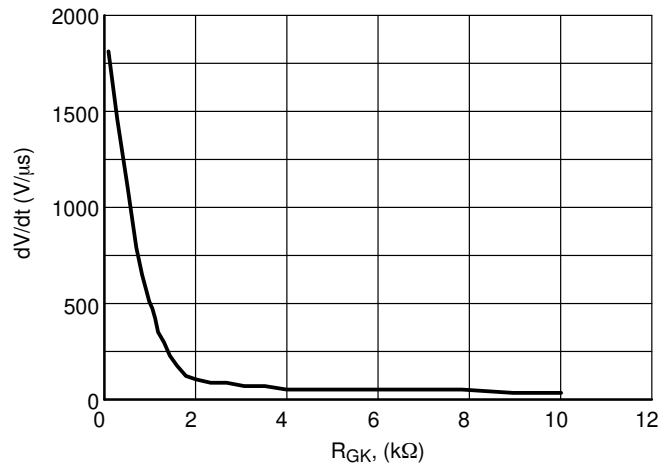


Figure 10. dV/dt vs. R_{GK}

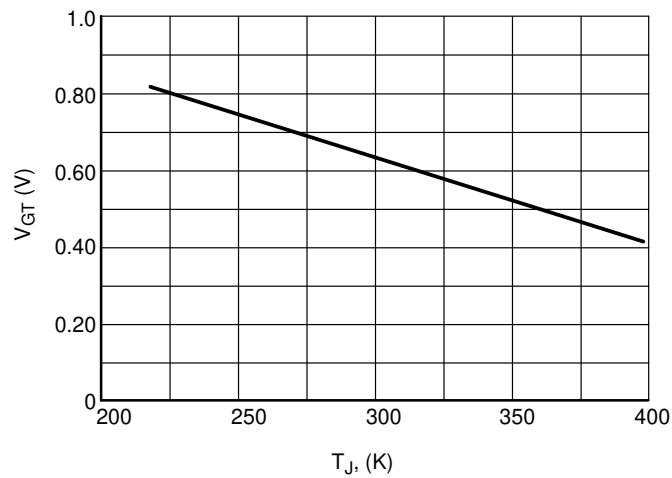
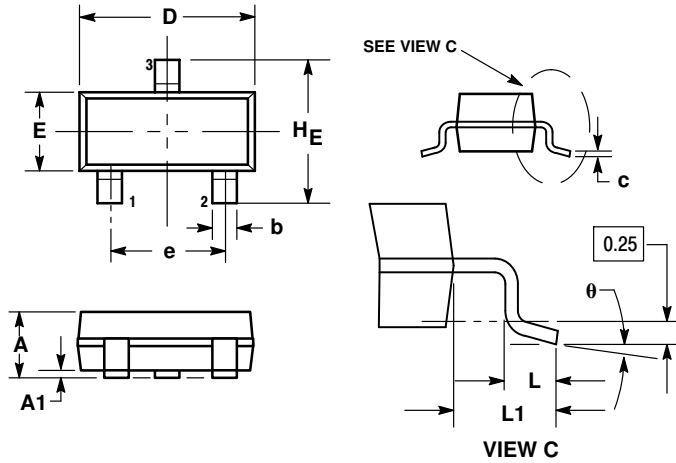


Figure 11. Gate Triggering Voltage vs. T_J

NYC0102BLT1G

PACKAGE DIMENSIONS

SOT-23 (TO-236)
CASE 318-08
ISSUE AP



NOTES:

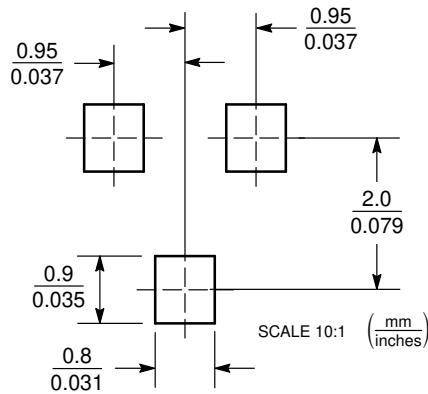
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
c	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
e	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104
θ	0°	---	10°	0°	---	10°

STYLE 8:

- PIN 1. ANODE
- NO CONNECTION
- CATHODE

SOLDERING FOOTPRINT



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